

Japan TC Chapter Compound Semiconductor Materials Global Technical Committee

Liaison Report

Feb. 16, 2022

v1

Meeting Information

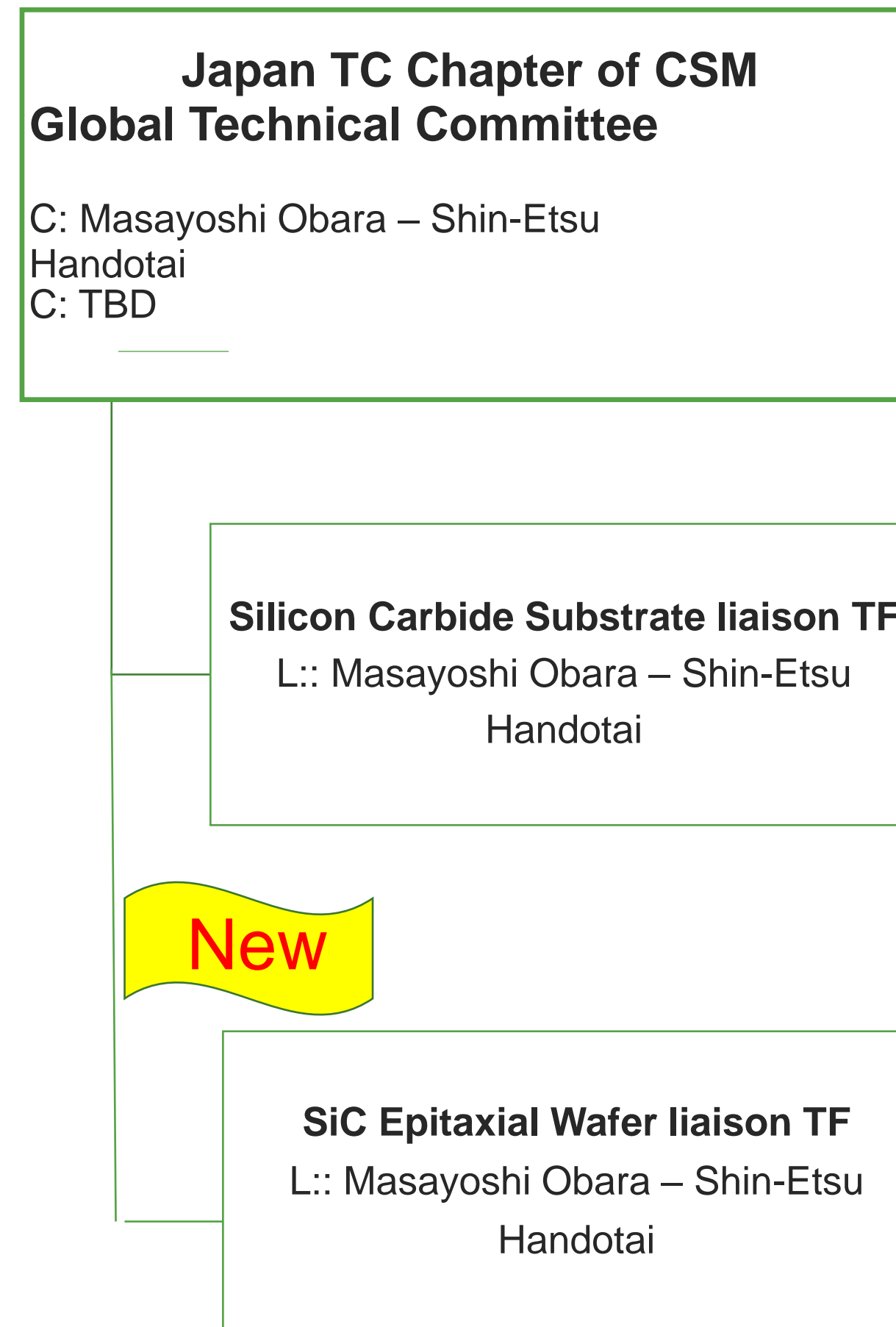
- Last meeting
 - Jan. 19, 2022 at Japan Winter 2022 Meetings
 - OVTCCM
- Next meeting
 - 2023 Spring, Exact date and time will be determined.
 - OVTCCM

<http://www.semi.org/en/standards-events>

Leadership

- Co-Chairs: Masayoshi Obara (Shin-Etsu Handotai Co., Ltd.)

Organization Chart



New TFOF

- **SiC Epitaxial Wafer liaison TF**

- Charter: Discussions will be held in Japan to support and complement Silicon Carbide Epitaxial Wafer revision and new standards development activities in other regions.
- Scope: To cover the scope of the SiC Epitaxial Wafer Task Force for its on existing SEMI Silicon Carbide Standards and new Standards as such become necessary.

Ballot Review

Doc #	Document Title	TC Chapter Action
None		

#1: Passed ballots and line items will be submitted to the ISC Audit & Review Subcommittee for procedural review.

#2: Failed ballots and line items were returned to the originating task forces for re-work and re-balloting or abandoning.

Authorized Activities

Doc #	Type	SC/TF/WG	Details
None			

Task Force Highlights

- The Japan TC Chapter approved a New TFOF 'SiC Epitaxial Wafer Liaison TF'. Please refer the New TFOF page.
- Ballot Review meetings
 - 2022 Cycle 1: 4 China ballots were reviewed on February 9, 2022

5-Year Review

Designation #	Standard Title	Action By	Assigned to
None			

Thank you!

Staff Contact: Mami Nakajo (mnakajo@semi.org)
